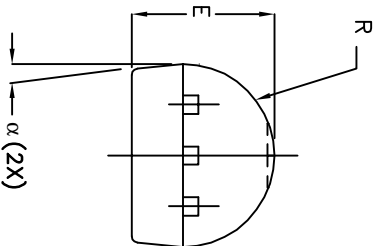
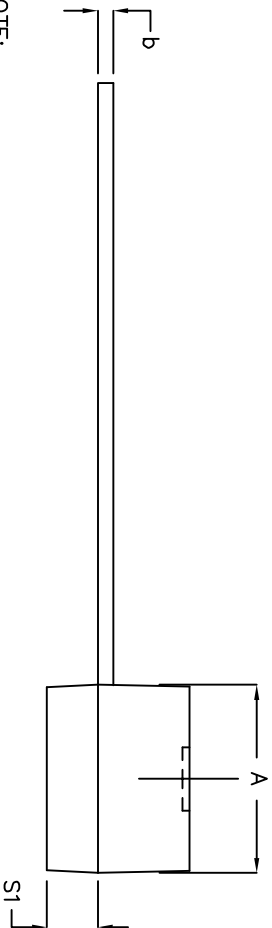
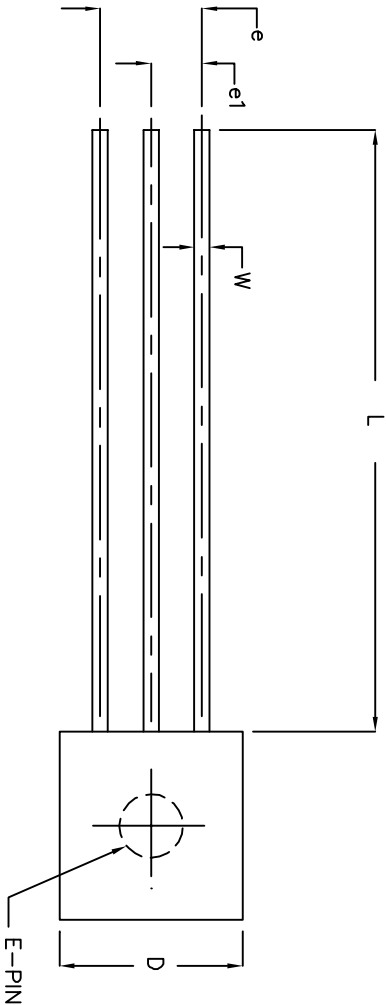


REVISIONS			
LTR	DESCRIPTION	DATE	APPROVED
A	ORIGINAL ISSUE	12/01	JFD

SYMBOL	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.170	.195	4.32	4.95
b	.014	.020	0.36	0.51
E	.130	.155	3.30	3.94
e	.095	.105	2.41	2.67
e1	.045	.055	1.14	1.40
L	.500	.610	12.70	15.49
R	.085	.095	2.16	2.41
S1	.045	.060	1.14	1.52
W	.016	.022	0.41	0.56
D	.175	.195	4.45	4.95
α	4°	6°	4°	6°



- NOTE:
1. PACKAGE OUTLINE EXCLUSIVE OF ANY MOLD FLASHES DIMENSION.
 2. PACKAGE OUTLINE EXCLUSIVE OF BURR DIMENSION.
 3. CONTROLLED DIMENSION IS INCH.
 4. MEETS JEDEC TO-226 AA.

SIGNATURE	DATE	<div> <div> DALLAS MAXIM </div> <div> SEMICONDUCTOR </div> </div> MARKETING OUTLINE, TO-92, 3-PIN			
ASST. ENGR:					
PROD. ENGR:					
DES. ENGR:					
CHECK BY: TWM	12/01				
DRAWN BY: JFD	12/01	SIZE D	FSCW NO 56-G0006-001	DWG NO	REV A
SCALE N/A					
					SHEET 1 OF 1